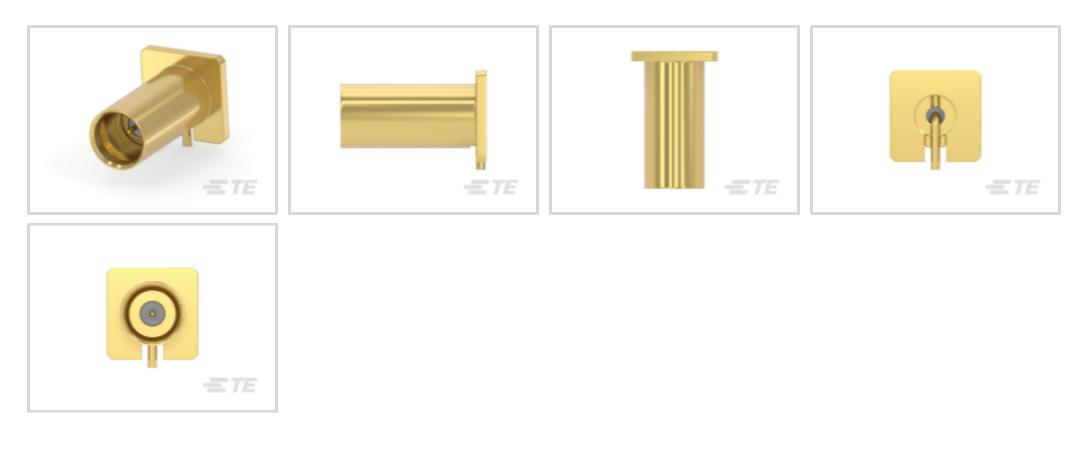


TE Internal #: 2406830-1 SMP RF Interface, Plug, 50 Ω, Push-On, 0 – 18 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, -65 – 165 °C [-85 – 329 °F]

View on TE.com >



Connectors > RF Connectors > Coax Connectors



RF Interface: SMP

RF Connector Style: Plug

RF Connector Mated Outer Diameter (Approximate): 10.28 mm [.315 in]

Impedance: 50Ω

RF Connector Coupling Mechanism: Push-On

Features

Product Type Features

RF Interface	SMP
RF Connector Style	Plug
Connector System	Cable-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
PCB Mount Orientation	Vertical
Number of Positions	1
Number of Coaxial Contacts	1
Electrical Characteristics	
Impedance	50 Ω
Body Features	
Body Underplating Material	Copper
Body Material	Brass
Body Material Finish	Plated

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SMP RF Interface, Plug, 50 Ω, Push-On, 0 – 18 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, -65 – 165 °C [-85 – 329 °F]



Body Plating Material	Gold
Contact Features	
RF Connector Center Contact Plating Material	Gold
RF Connector Center Contact Material	Beryllium Copper
Termination Features	
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
RF Connector Coupling Mechanism	Push-On
RF Contact Captivation Method	Mechanical
Detent	With
Dimensions	
Profile Height from PCB	9.53 mm[.375 in]
RF Connector Mated Outer Diameter (Approximate)	10.28 mm[.315 in]
Usage Conditions	
Operating Temperature Range	-65 – 165 °C[-85 – 329 °F]
Operation/Application	
Operating Frequency	0 – 18 GHz
Circuit Application	Signal
Packaging Features	
Packaging Method	Tray
Other	
Dielectric Material	PEEK
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 202 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold:

SMP RF Interface, Plug, 50 Ω , Push-On, 0 – 18 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, -65 – 165 °C [-85 – 329 °F]



Pb (4% in Component Part) Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

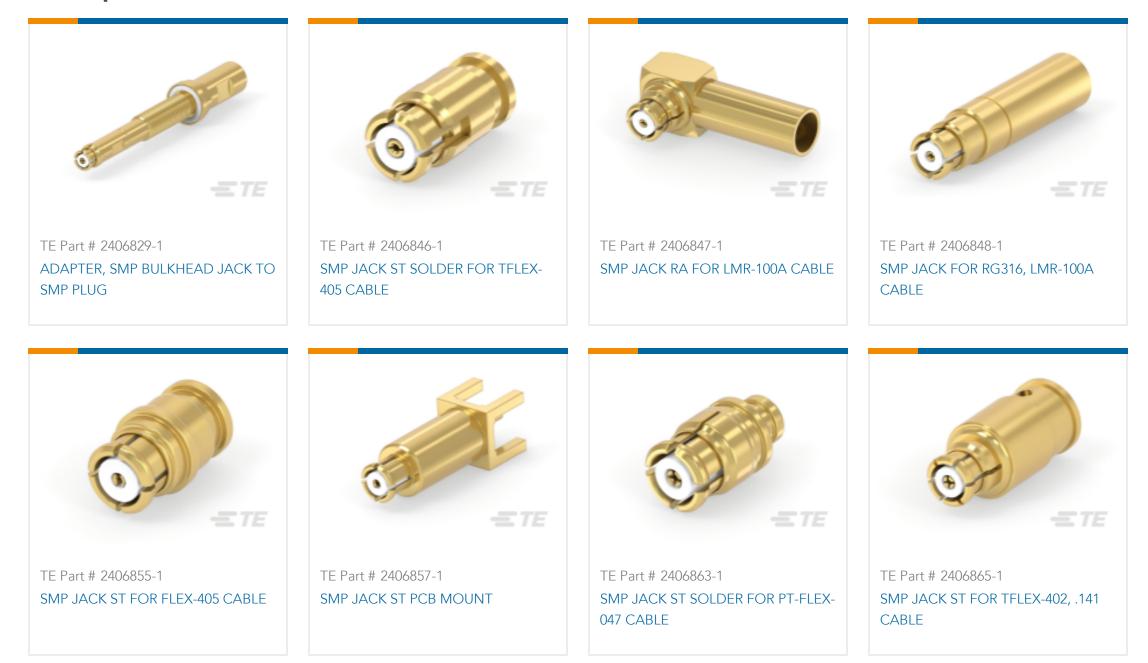
Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Halogen Content

Solder Process Capability

2406830-1

SMP RF Interface, Plug, 50 Ω, Push-On, 0 – 18 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, -65 – 165 °C [-85 – 329 °F]



TE Part # 2406869-1 SMP JACK RA FOR TFLEX-405 CABLE	TE Part # 2406843-1 SMP JACK ST SOLDER FOR TFLEX- 405 CABLE	TE Part # 2406850-1 SMP JACK ST FOR FLEX-405 CABLE	TE Part # 2406864-1 SMP JACK ST FOR TFLEX-402, .141 CABLE

Customers Also Bought



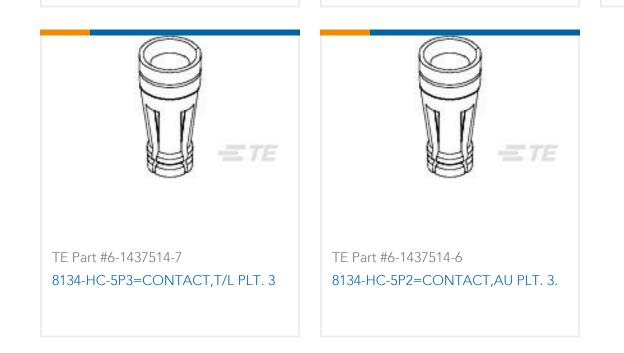
TE Part #7-1437514-0

TE Part #1053354-1

03P CST100 SHRD HDR ASSY LF

TE Part #3-644894-3

TE Part #7-1625867-8



Documents

Product Drawings SMP PLUG RA FOR PCB SMT

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2406830-1_1.2d_dxf.zip

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SMP RF Interface, Plug, 50 Ω , Push-On, 0 – 18 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, -65 – 165 °C [-85 – 329 °F]



English

Customer View Model ENG_CVM_CVM_2406830-1_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2406830-1_1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages 1307191 RF Coax Products Catalog

English

Product Specifications Product Specification

English